# Multiple Connections in Bluetooth LE Central Device

## 1. Introduction

NXP provides a complete Bluetooth LE solution, that allows to create applications that supports up to 8 simultaneous connections using the KW36/35 SoC. The connections can be configured to be a Central or Peripheral device.

Temperature Collector demo application is used to describes the procedure to enable multiple connections on a Bluetooth LE Central device.

## 2. Prerequisites

The following items are required to complete the implementation of multiple connections on a Central device:

- At least 3 FRDM-KW36
- FRDM-KW36 SDK Package
- MCUXpresso IDE
- Temperature Collector Demo Application
- Temperature Sensor Demo Application
- Tera Term or any serial terminal software

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## 3. Enabling multiple connections on Bluetooth LE Central device

This section describe the procedure to enable multiple connections using the Temperature Collector application and MCUXpresso IDE.

## 3.1. Creating a workspace and importing the SDK to MCUXpresso IDE

- 1. Download the FRDM-KW36 SDK from <a href="https://mcuxpresso.nxp.com/en/select?device=FRDM-KW36">https://mcuxpresso.nxp.com/en/select?device=FRDM-KW36</a>.
- 2. Open MCUXpresso IDE.

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3. Create or Select the workspace directory and click OK.

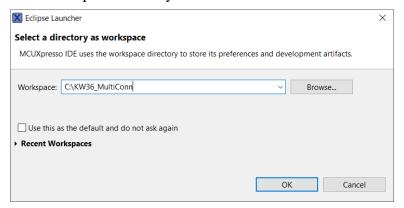


Figure 1. Select a workspace

4. If there is no previous SDK installed, import the **FRDM-KW36 SDK**. To install a new SDK in MCUXpresso IDE, drag and drop the SDK .*zip* file into the **Installed SDKs** view.

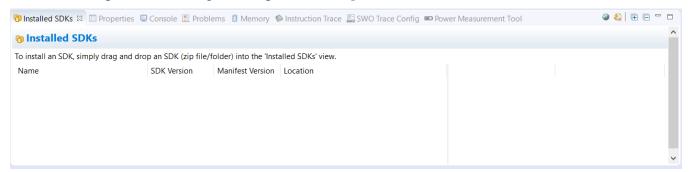


Figure 2. MCUXpresso Installed SDKs view

5. Once installed, MCUXpresso IDE looks as Figure 3:

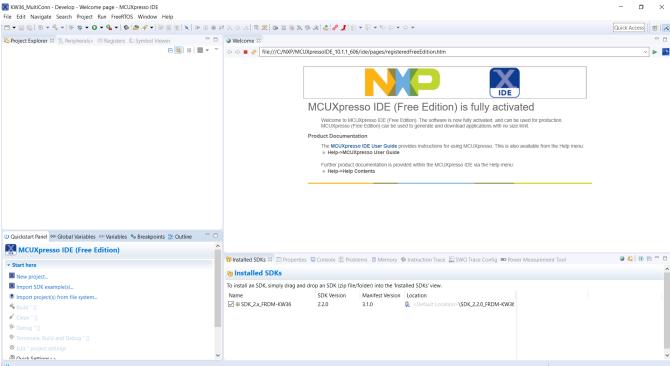


Figure 3. MCUXpresso IDE main screen

## 3.2. Importing an SDK example.

1. In Quickstart Panel, and click Import SDK example(s)... option.



Figure 4. Quickstart Panel

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2. Select the **frdmkw36 SDK** from available boards and click **Next** > button.

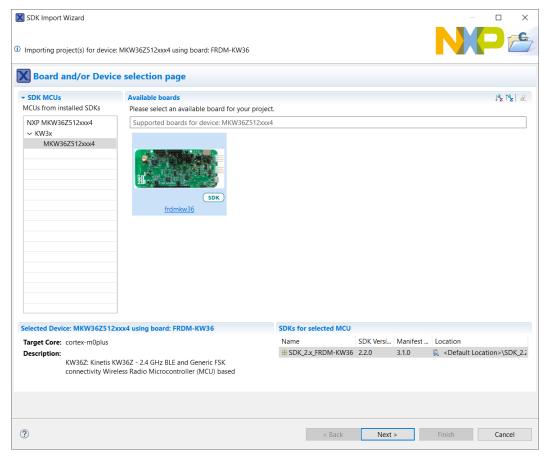


Figure 5. SDK import wizard

3. In **Examples view**, expand *wireless\_examples* folder, then *bluetooth* subfolder and *temp\_coll* subfolder. Select **freertos** and click **Finish.** 

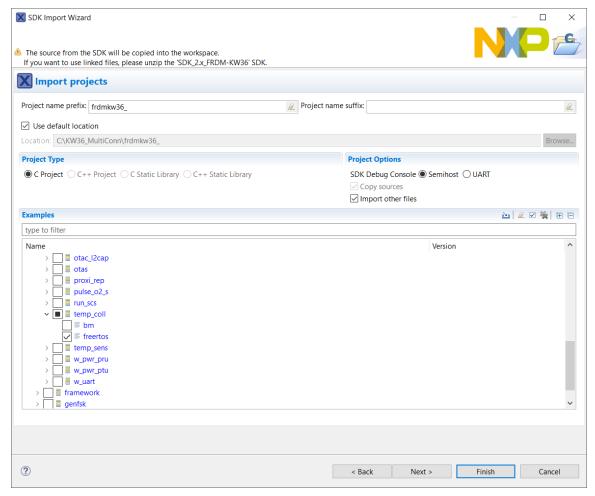


Figure 6. Importing Temperature Collector project to workspace

## 4. Adding multiple connections support to Temperature Collector

Once the Temperature Collector application is imported to MCUXpresso IDE, the following files need to be modified to enable multiple connections: app\_preinclude.h and temperature\_collector.c.

## 4.1.1. Modifying app\_preinclude.h file.

1. In**Project Explorer** view, expand the Temperature Collector project and locate *app\_preinclude.h* file in source folder.

#### Adding multiple connections support to Temperature Collector

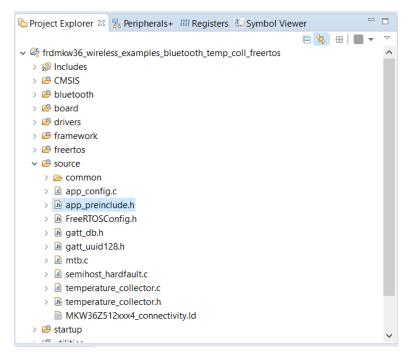


Figure 7. app\_preinclude.h file

2. Add the following define. This define determines the maximum number of simultaneous connections. The maximum number of connections permitted is 8.

3. Locate the gTmrStackTimers\_c define and modify as below. This define needs to be increased by 1 for each device you want to connect with pairing.

```
#define gTmrStackTimers_c (6 + gAppMaxConnections_c)
```

4. If debug is required, modify the following macro to disable the usage of low power mode:

```
/* Enable/Disable PowerDown functionality in PwrLib */
#define cPWR_UsePowerDownMode 0
```

### 4.1.2. Modifying temperature\_collector.c file.

1. In **Project Explorer** view, expand the Temperature Collector project and locate *temperature\_collector.c* file at *source* folder.

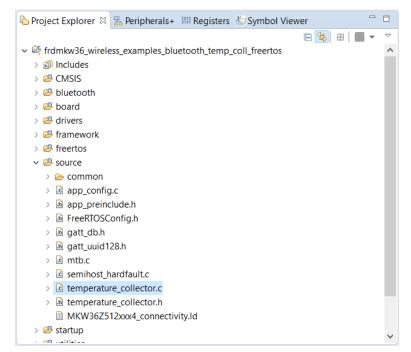


Figure 8. temperature\_collector.c file

2. Locate the static appPeerInfo\_t mPeerInformation declaration and modify it as below:

```
static appPeerInfo_t mPeerInformation[gAppMaxConnections_c];
```

3. Create a global variable which will be used as active connections counter. This variable can be placed below mPeerInformation[gAppMaxConnections\_c] declaration.

```
uint8_t mActiveConnections = 0;
```

4. Locate the following functions declaration and add the **deviceId\_t peerDeviceId** parameter as below.

```
    static void BleApp_StoreServiceHandles

        (
                        deviceId_t
                                         peerDeviceId,
                        gattService_t
                                        *pService
       );
2) static void BleApp_StoreDescValues
        (
                                         peerDeviceId,
                        deviceId t
                        gattAttribute t
                                             *pDesc
        );
3) static void BleApp_PrintTemperature
     Multiple Connections in Bluetooth LE Central Device, Application Notes, Rev. 0, 04/2019
```

5. Locate the declaration of **DisconnectTimerCallback** function and comment the lines as below. You may find the declaration within an **#if** - **#endif** preprocessor directive.

```
/*
#if (cPWR_UsePowerDownMode)
static void DisconnectTimerCallback(void* pParam);
#endif
*/
```

6. Go to BleApp\_HandleKeys function and modify it as below. This will trigger the manual disconnection of all the connected peripheral devices when low power is disabled.

7. Go to BleApp\_Config function and modify the mPeerInformation variable initialization as below.

- 8. Go to BleApp ScanningCallback to function
  - a. At **case** *gDeviceScanned\_c*, modify as below.

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```
#endif } } }
```

b. At case gScanStateChanged\_c, locate and modify the #if (cPWR\_UsePowerDownMode) preprocessor directive as below.

```
#if (cPWR_UsePowerDownMode)
                    Led10ff();
                      * Go to sleep */
                    #ifdef MULTICORE_HOST
                        #if gErpcLowPowerApiServiceIncluded_c
                             PWR_ChangeBlackBoxDeepSleepMode(3);
                    #else
                        if(mActiveConnections > 0)
                         PWR_ChangeDeepSleepMode(1);
                         }
                        else
                         PWR_ChangeDeepSleepMode(3);
                    #endif
#else
                    LED_StopFlashingAllLeds();
                    Led1Flashing();
                    Led2Flashing();
                    Led3Flashing();
                    Led4Flashing();
#endif
```

- 9. Go to BleApp\_ConnectionCallback function.
  - a. At case *qConnEvtConnected c*, locate and modify the following lines as below.

```
1) mPeerInformation[peerDeviceId].deviceId = peerDeviceId;
```

- 2) mPeerInformation[peerDeviceId].isBonded = FALSE;
- 3) Gap\_CheckIfBonded(peerDeviceId, &mPeerInformation[peerDeviceId].isBonded);
- 5) BleApp\_StateMachineHandler(mPeerInformation[peerDeviceId].deviceId, mAppEvt PeerConnected c);
- b. At case gConnEvtConnected\_c, add the following line below
  mPeerInformation[peerDeviceId].isBonded = FALSE;
  mActiveConnections++;
- c. At case gConnEvtDisconnected\_c, locate and modify the following lines as below.
  - 1) mPeerInformation[peerDeviceId].deviceId = gInvalidDeviceId\_c;
  - 2) mPeerInformation[peerDeviceId].appState = mAppIdle\_c;

- d. At **case** *gConnEvtDisconnected\_c*, add the following line below mPeerInformation[peerDeviceId].appState = mAppIdle\_c; mActiveConnections --;
- e. At case gConnEvtDisconnected\_c, locate the #if (cPWR\_UsePowerDownMode) preprocessor directive and modify as below.

```
#if (cPWR_UsePowerDownMode)
              * Go to sleep */
            #ifdef MULTICORE_HOST
                #if gErpcLowPowerApiServiceIncluded_c
                    PWR_ChangeBlackBoxDeepSleepMode(3);
            #else
                if(mActiveConnections > 0)
                PWR_ChangeDeepSleepMode(1);
                }
                else
                PWR_ChangeDeepSleepMode(3);
            #endif
            Led10ff();
#else
            LED_TurnOffAllLeds();
            LED_StartFlash(LED_ALL);
#endif
```

f. At case *gConnEvtPairingComplete\_c*, locate and modify the following line as below.

BleApp\_StateMachineHandler(mPeerInformation[peerDeviceId].deviceId, mAppEvt\_PairingComplete\_c);

g. At case *gConnEvtEncryptionChanged\_c*, locate and modify the following line as below.

```
if( gBleSuccess_c != BleApp_ConfigureNotifications(peerDeviceId) )
```

10. Go to BleApp\_ServiceDiscoveryCallback function. At case gServiceDiscovered\_c, modify as below.

```
case gServiceDiscovered_c:
        BleApp_StoreServiceHandles(peerDeviceId, pEvent->eventData.pService);
break:
```

11. Go to BleApp\_StoreServiceHandles function.

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a. Add deviceId\_t peerDeviceId in the function arguments.

```
static void BleApp_StoreServiceHandles (deviceId_t peerDeviceId, gattService_t *pService)
```

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b. Modify mPeerInformation.customInfo.tempClientConfig.hService as below.

```
/* Found Temperature Service */
mPeerInformation[peerDeviceId].customInfo.tempClientConfig.hService = pService->startHandle;
```

c. Modify the mPeerInformation.customInfo.tempClientConfig.hTemperature as below.

```
/* Found Temperature Char */
mPeerInformation[peerDeviceId].customInfo.tempClientConfig.hTemperature = pService->
aCharacteristics[i].value.handle;
```

d. At case gBleSig CharPresFormatDescriptor d, modify as below.

e. At case gBleSig\_CCCD\_d, modify as below.

12. Go to BleApp\_StoreDescValues function and modify as below.

13. Go to BleApp PrintTemperature function and modify as below.

```
static void BleApp_PrintTemperature(deviceId_t peerDeviceId, uint16_t temperature)
{
    shell_write("Temperature: ");
    /*
    * The following lines will print the id of the device reporting the temperature.
    * Then will print a blank space and the temperature. I.E: Temperature: 0 25 C
    */
    shell_writeDec(peerDeviceId);
    shell_write(" ");
```

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```
shell_writeDec(temperature/100);
if (mPeerInformation[peerDeviceId].customInfo.tempClientConfig.tempFormat.unitUuid16 == 0x272F)
{
    shell_write(" C\r\n");
}
else
{
    shell_write("\r\n");
}
```

14. Go to BleApp\_GattClientCallback function and modify the BleApp\_StoreDescValues function call as below.

BleApp\_StoreDescValues(serverDeviceId, mpCharProcBuffer);

15. Go to BleApp\_GattNotificationCallback function and modify as below.

```
static void BleApp_GattNotificationCallback
    deviceId_t serverDeviceId,
   uint16_t
                characteristicValueHandle,
   uint8_t*
                aValue,
   uint16_t
                valueLength
)
{
    if (characteristicValueHandle == mPeerInformation[serverDeviceId].customInfo.tempClientConfig.hTemperature)
        BleApp_PrintTemperature(serverDeviceId, *(uint16_t*)aValue);
#if (cPWR UsePowerDownMode)
        Restart Wait For Data timer
        TMR_StartLowPowerTimer(mAppTimerId,
                       gTmrLowPowerSecondTimer_c,
                       TmrSeconds(gWaitForDataTime_c),
                       DisconnectTimerCallback, NULL);
#endif
```

16. Go to BleApp\_StateMachineHandler function.

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a. Modify the switch (mPeerInformation.appState) statement as below.

```
switch (mPeerInformation[peerDeviceId].appState)
```

b. At case mAppIdle\_c, modify as below.

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c. At case mAppExchangeMtu\_c, locate and modify the following line as below.

```
mPeerInformation[peerDeviceId].appState = mAppServiceDisc_c;
```

- d. At case mAppServiceDisc\_c, locate and modify the following lines as below.
  - 1) mPeerInformation[peerDeviceId].appState = mAppReadDescriptor\_c;
  - 2) if (mPeerInformation[peerDeviceId].customInfo.tempClientConfig.hTempDesc)
  - 3) mpCharProcBuffer->handle = mPeerInformation[peerDeviceId].customInfo.tempClientConfig.hTempDesc;
  - 4) GattClient\_ReadCharacteristicDescriptor(mPeerInformation[peerDeviceId].deviceId, mpCharProcBuffer,23);
- e. At case mAppReadDescriptor c, locate and modify the following lines as below.
  - if (mPeerInformation[peerDeviceId].customInfo.tempClientConfig.hTempCccd)
  - 2) if( gBleSuccess\_c != BleApp\_ConfigureNotifications(peerDeviceId) )
  - 3) mPeerInformation[peerDeviceId].appState = mAppRunning\_c;
- f. At case mAppRunning\_c, locate and modify the following lines as below.

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17. Go to BleApp\_ConfigureNotifications function, locate and modify the following lines as below.

```
    static bleResult_t BleApp_ConfigureNotifications(deviceId_t peerDeviceId)
    mpCharProcBuffer->handle = mPeerInformation[peerDeviceId].customInfo.tempClientConfig.hTempCccd;
    GattClient_WriteCharacteristicDescriptor(mPeerInformation[peerDeviceId].deviceId, mpCharProcBuffer, sizeof(value), (void*)&value);
```

18. Go to DisconnectTimerCallback function and comment the lines as below.

```
/*
#if (cPWR_UsePowerDownMode) //@AV
static void DisconnectTimerCallback(void* pParam)
{
    if (mPeerInformation.deviceId != gInvalidDeviceId_c)
    {
        Gap_Disconnect(mPeerInformation.deviceId);
    }
}
#endif
*/
```

## 5. Testing a Central device with multiple connections

Temperature Sensor demo application is needed alongside with the Temperature Collector demo application to demonstrate the functionality of multiple connections. The following steps show how to generate two or more peripheral devices enabled with the Temperature Sensor to test multiple connections in a Central device.

## 5.1. Importing the Temperature Sensor Example

1. See Section 3.2 Importing an SDK Example and follow the steps described. In step number 3, select **temp\_sens** instead of **temp\_coll**. This imports the Temperature Sensor demo application into the workspace.

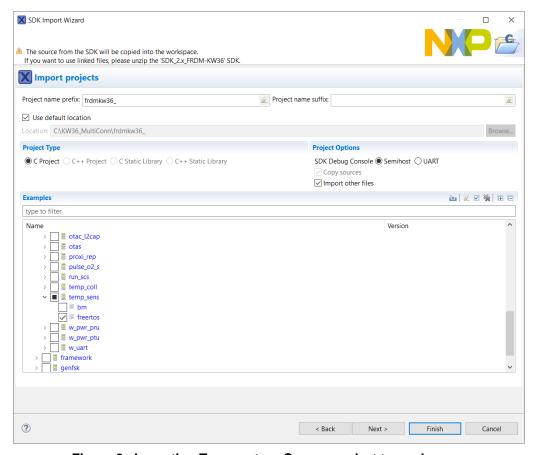


Figure 9. Importing Temperature Sensor project to workspace

- 2. Temperature Sensor application, has low-power mode enabled by default and also, as Temperature Collector, it has a timer that disconnects the device once the temperature is reported. To avoid the disconnection, the following actions can be taken:
  - a) Open Temperature Sensor's *app\_preinclude.h* file and modify the following macro to disable low power mode:

```
/* Enable/Disable PowerDown functionality in PwrLib */
#define cPWR_UsePowerDownMode 0
```

b) Open Temperature Sensor's *temperature\_sensor.c* file, go to **BleApp\_SendTemperature** function and modify the following lines as below:

3. If debug is required, open Temperature Sensor's *app\_preinclude.h* file and modify the following macro to disable low-power mode:

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```
/* Enable/Disable PowerDown functionality in PwrLib */
#define cPWR_UsePowerDownMode 0
```

## 5.2. Building and downloading the projects

1. Select the **Temperature Collector** project in **Project Explorer** view and compile it by pressing the **Build** button at **Quickstart Panel** view.

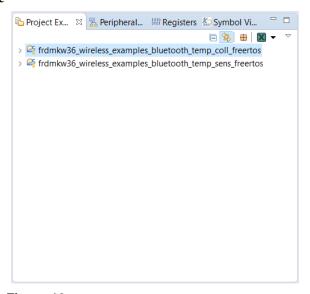


Figure 10. Temperature Collector project selected

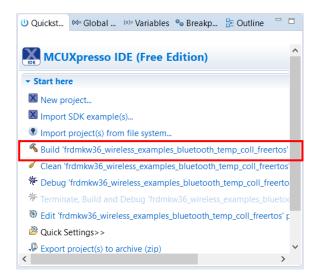


Figure 11. Build Project button

2. Connect the FRDM-KW36 which acts as Temperature Collector and wait for the drivers to be installed.

3. Once the drivers are installed, make sure Temperature Collector project is still selected and download the code to the FRDM-KW36 board by pressing **Debug** button in **Quickstart Panel** view.

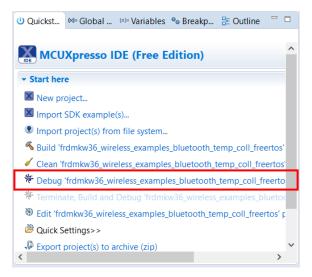


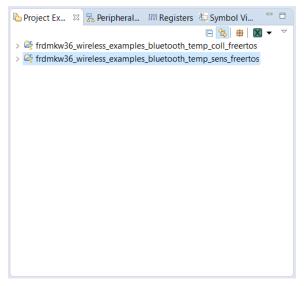
Figure 12. Build Project button

4. Stop the debugger by pressing **Terminate** button and disconnect the board.



Figure 13. Terminate button

5. Repeat the previous steps for the remaining boards that acts as Temperature Sensors. Make sure the project selected now is the Temperature Sensor project.



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Figure 14. Temperature Sensor project selected

## 5.3. Running the application

- 1. Connect the FRDM-KW36 flashed with the Temperature Collector application.
- 2. Launch TeraTerm and open the assigned port to the FRDM-KW36 board.

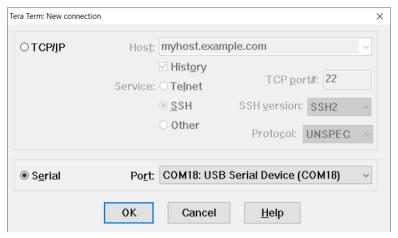


Figure 15. Open Serial Port

3. Expand Setup menu and click over Serial Port. Make sure to configure the settings as in Figure 16.

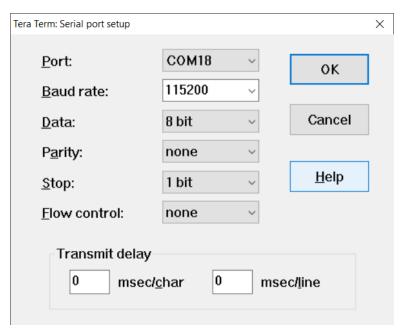


Figure 16. Configure Serial Port

4. Press Reset (SW1) button on the FRDM-KW36 board. The Temperature Collector should be displayed as Figure 17.

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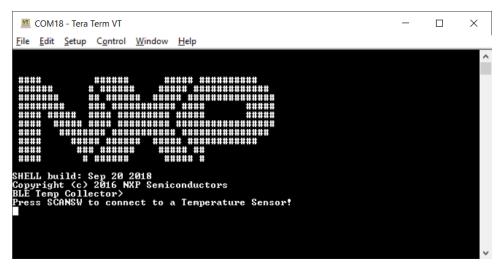


Figure 17. Temperature Collector

- 5. Connect the boards flashed with the Temperature Sensor application.
- 6. Press SW2 and the Temperature Collector shall start scanning for peripherals.

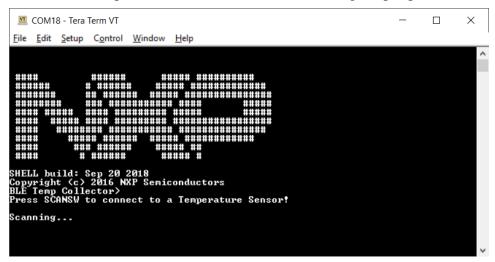


Figure 18. Temperature Collector searching for Temperature Sensors

7. Press SW2 on a board flashed with a Temperature Sensor to start advertising. Once the Temperature Sensor is connected, the Temperature Collector shows the temperature reported by the sensor.



Figure 19. Temperature Collector connected to first Temperature Sensor

8. Repeat steps 6 and 7 to connect a second Temperature Sensor to the Temperature Collector.

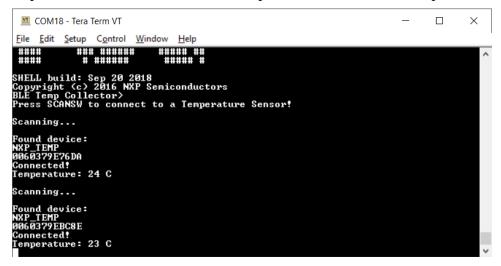


Figure 20. Temperature Collector connected to second Temperature Sensor

- 9. Press SW2 on each Temperature Sensor to trigger a temperature report to the Temperature Collector.
- 10. If a disconnection is performed, the Temperature Collector shows a disconnection message for each board connected.

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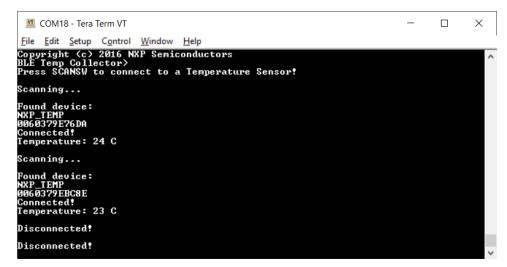


Figure 21. Temperature Sensors disconnected from Temperature Collector

## 6. Revision history

Rev. Number	Date	Substantive Change
0	05/2019	Initial release

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